

SESSION ID: PL1403C

HOW LOCKHEED MARTIN STREAMLINED THEIR DIGITAL THREAD WITH ZUKEN & PTC



ZUKEN

SPEAKER(s):

Grant Denis

Lockheed Martin

Joe Richlen

Zuken USA Inc.







LOCKHEED MARTIN PROBLEM DEFINITION

Grant Denis

Lockheed Martin



ECAD DATA AT LOCKHEED MARTIN RMS

- Multiple sites of different heritage
- Located across the country
- Common ECAD toolset for PCB and Cable
- Workshare

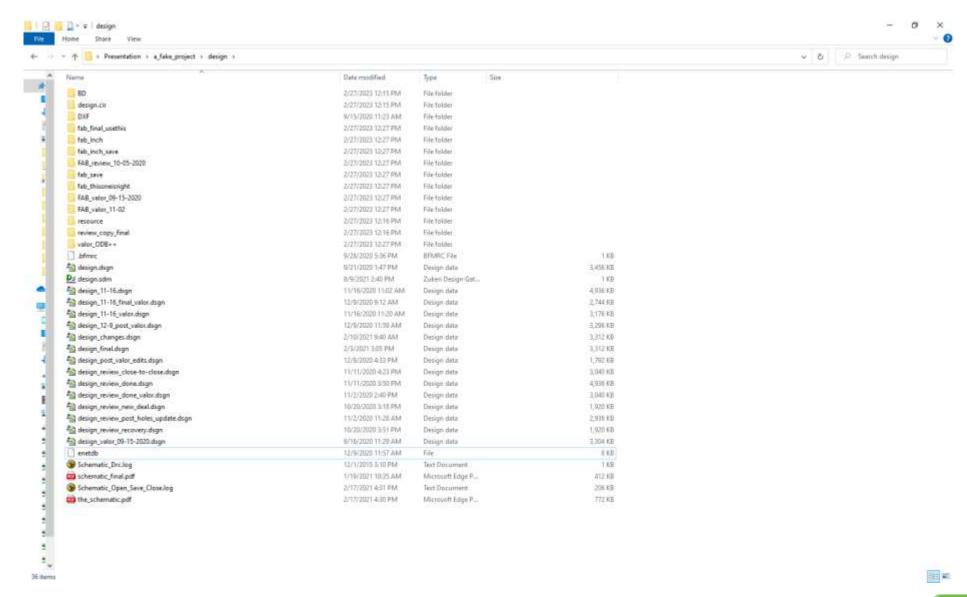
ECAD DATA MANAGEMENT

- Electrical CAD data not managed well
 - PCB Data
 - Cable Harness Data
- Manual PLM Release, Inconsistent, Errors
 - Rework
 - Scrap
 - Confusion





THE WAY THINGS WERE



WHY NOT CHANGE?

- Workgroup Manager methodology
 - Performance
 - Too tightly coupled to versions
 - Capabilities
 - Long term support



PLM based around MCAD

Inertia



WHAT WAS NEEDED?

- Bring ECAD Engineering Data under controlled processes
 - Repeatable
 - Trackable
- Check in/out capabilities for WIP ECAD data
- Control of non-PLM artifacts
- Simple way to move data to PLM for Release









ZUKEN®

THE ZUKEN SOLUTION: ENGINEERING DATA MANAGEMENT (EDM)

Joe Richlen

Zuken USA Inc.



ZUKEN BACKGROUND - GLOBAL PRESENCE



Founded	December 17, 1976
Corporate Headquarters	Yokohama, Japan
North American Headquarters	Westford, MA
European Headquarters	Munich, Germany
Operational Excellence	Profitable, no debt

Japan & Asia 📠



Japan	Gli Global Headquarters/ R&D Center (Yokohama) Shin-Yokohama Building (Yokohama) Center Minami Building (Yokohama) Nagoya Branch (Nagoya) Kansai Branch (Osaka)
Korea	Zuken Korea Inc.
Singapore	Zuken Singapore Pte. Ltd.
Talwan	Zuken Taiwan Inc.
China	Zuken Shanghai Technical Center Zuken Inc. Shenzhen Representative Office
India	Zuken India Private Limited

Americas



Europe

Germany



- - Zuken Group Ltd.
 Zuken UK Ltd.
 - Zuken UK Ltd.
 - Zuken GmbH (European Headquarters)
 - Zuken E3 GmbH ● Zuken E3 GmbH
 - Zuken GmbH (EMC Technology Center)
 - Zuken E3 GmbH Office Nord
 - Zuken E3 GmbH (Global Automotive and Transportation Competence Center)
- Poland Zuken E3 GmbH Sp.z o.o
- Switzerland

 Zuken E3 GmbH, Zweigniederlassung
- France Zuken S.A.
 Italy Zuken Srl
- Netherlands Zuken GmbH, Sales Office Benelux

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ZUKEN BACKGROUND - SYSTEMS DESIGN PLATFORMS





Solution Model-Based Systems Engineering





- Hardware Architecture Design
- System Partitioning
- 3D Printed Circuit, Multi-board Layout
- ECAD/MCAD Co-design
- Chip/Package/Board Co-design



Electronic Design

- Electrical Wire Harness Engineering
- Fluid Controls Engineering
- Cabinet, Panel, Wire Harness and Formboard Layout
- Manufacturing and Documentation



Electrical Design

Library & Design Data Management for Electronic and Electrical Engineering









WHY EDM? FILE MANAGEMENT

- Native ECAD Data
- Shared Mechanical Data
- Analysis and Simulation Data
- Engineering Notes
- Component Parametric Data
- Design Rules/Guidelines
- Manufacturing Rules/Guidelines

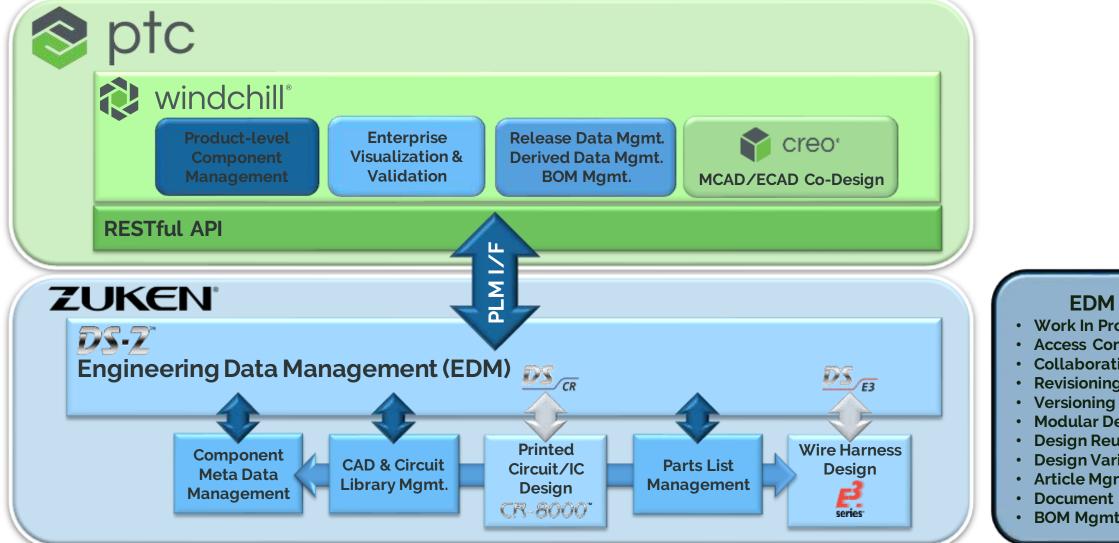


WHY EDM? CONSISTENT PROCESS

- A collaborative environment
- Accountability
- Accessibility
- Workflows
- Auto-generation of design outputs:
 - Assembly/Manufacturing Data
 - Design Review/Test Data
 - Bill-of-Materials
- Interface to PTC Windchill



PTC & ZUKEN JOINT SOLUTION



EDM

- Work In Process
- Access Control
- Collaboration
- Revisioning
- Modular Design
- Design Reuse
- **Design Variants**
- · Article Mgmt.
- **Document Mgmt.**
- **BOM Mgmt.**





LOCKHEED MARTIN RESULTS AND BENEFITS

Grant Denis

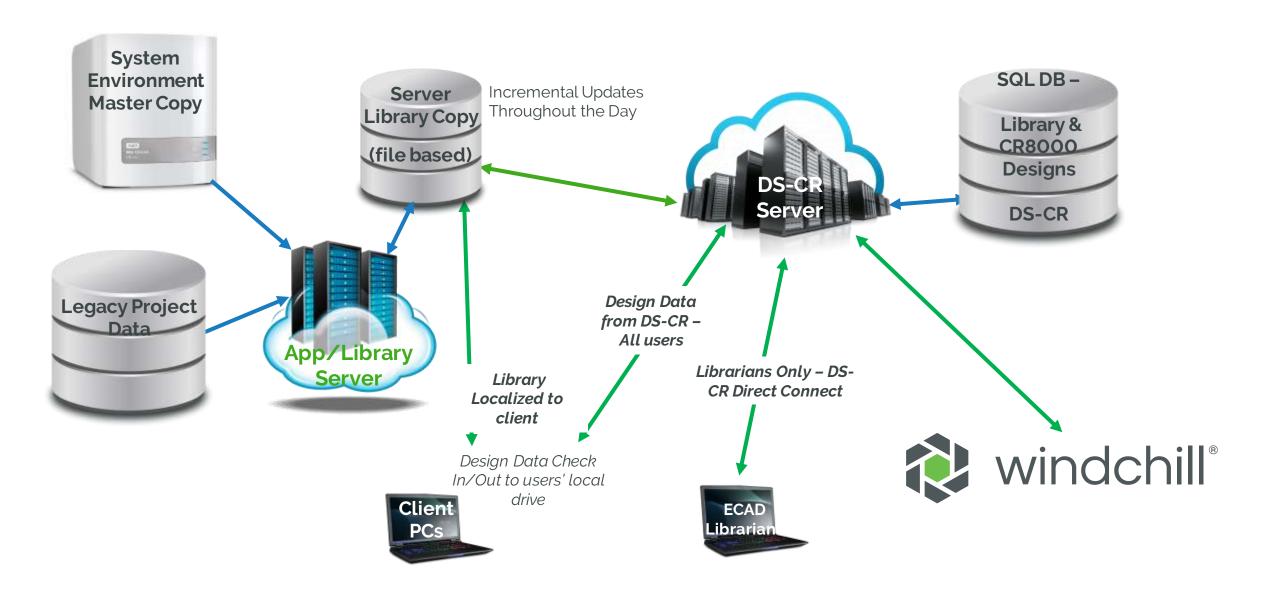
Lockheed Martin



WHAT WAS IMPLEMENTED?

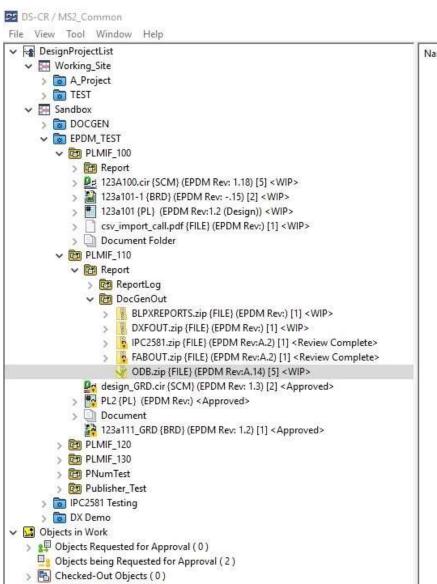
- DS-2 in production use for both PCB and Cable Harness
- Organized creation / management of data
 - Pushbutton transmission to Windchill
- Board & Schematic Data publishes as a viewable
 - □ No need for downstream users to have CAD tool
- Roughly 1 year from planning to production
 - Some code changes needed to support requirements

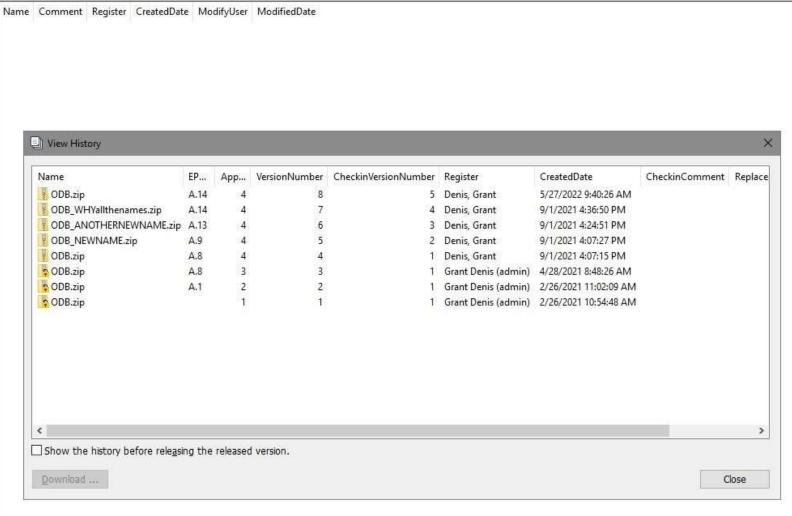
Zuken CR-8000/DS-CR Architecture



ZUKEN & WINDCHILL OBJECTS & LINKS Zuken Windchill 123100 123100-DWG **II** Schematic (Doc Part) **Zuken Schematic ECAD Schematic** Content 123101 123101-1 123101-TYPE PWB (Hardware Part) Content Ę **MFG Files** Releasable Document Dyn Ref Spec **Creo Dwg PWB** 123101-DWG 鐐 PWB (Doc Part) 123102 123102-1 **CCA (Hardware Part)** Content **Creo Dwg CCA** H PWB (Hardware Part) - 🚻 Cap - C1 Described By 123101 BOARD Resistor - R1, R2 Link (Content) **Zuken Board ECAD Board** ReferenceLink 123102-DWG (Dynamic 鐐 Reference Specs **CCA (Doc Part)** RMS custom)

DS-CR EXAMPLE





IMPACTS

- Common Process
 - Release process the same as MCAD once in Windchill
- Repeatable Process
- Control of Engineering Data



WHAT COMES NEXT?

- Retrieving Library parametric data from Windchill
- Automation / Linking of workflow status changes
- Single Sign On



KEY TAKEAWAY SUMMARY

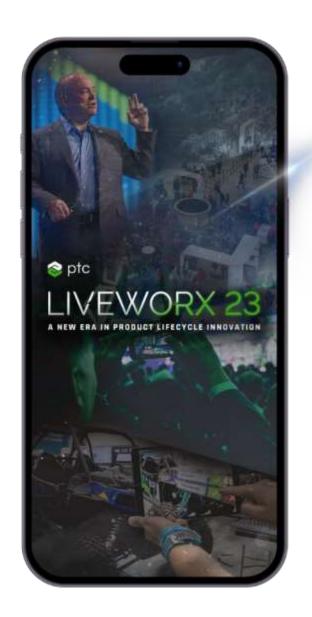
Grant Denis / Joe Richlen

KEY TAKEAWAY SUMMARY

- 1. Implementing an Engineering Data Management data framework with access controls and protections in conjunction with the Windchill REST API product release system integration.
- 2. Institute a consistent, repeatable, configuration-controlled design and manufacturing data flow through process and data automation.
- 3. Streamline the design and manufacture of electronic products, while providing easy access to accurate, timely product data throughout the products' development lifecycle to all stakeholders.

QUESTIONS?

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